



#### SURFACE MOUNT FAST SWITCHING DIODE

#### **Features**

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- **High Conductance**
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3, 4 and 5)

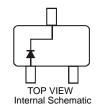
### **Mechanical Data**

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.006 grams (approximate)









## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current (Note 1)		I <sub>FM</sub>	500	mA
Average Rectified Output Current (Note 1)		I <sub>O</sub>	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	4.0 2.0	А

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P <sub>D</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-65 to +150	°C

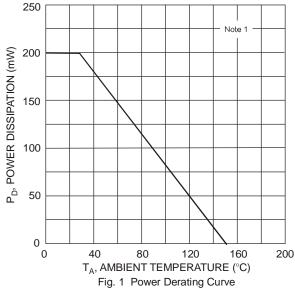
### Electrical Characteristics @TA = 25°C unless otherwise specified

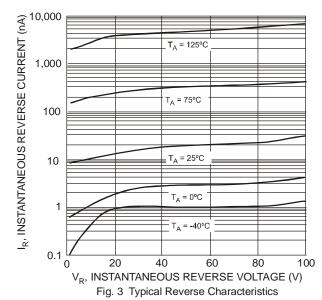
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	75	_	V	$I_R = 10\mu A$
		0.62	0.72		$I_F = 5.0 \text{mA}$
Forward Voltage	V <sub>F</sub>	_	0.855	V	$I_F = 10 \text{mA}$
Torward voilage		_	1.0		$I_F = 100 \text{mA}$
		_	1.25		$I_F = 150 \text{mA}$
	I <sub>R</sub>	I <sub>R</sub> —	1.0	μА	$V_R = 75V$
Reverse Current (Note 2)			50	F -	$V_R = 75V, T_J = 150$ °C
Reverse Guiterii (Note 2)			30		$V_R = 25V, T_J = 150$ °C
			25	nA	$V_R = 20V$
Total Capacitance	C <sub>T</sub>	_	2.0	pF	$V_R = 0$ , $f = 1.0MHz$
Dayarra Dagayary Tima			4.0		$I_F = I_R = 10 \text{mA},$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

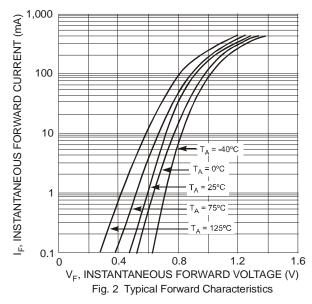
Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which Notes: can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

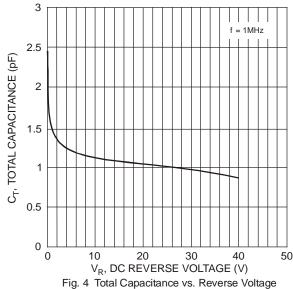
- Short duration pulse test used to minimize self-heating effect.
- No purposefully added lead. Halogen and Antimony Free.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- Product manufactured with Green Molding Compound and does not contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









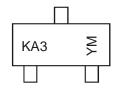


## Ordering Information (Notes 5 & 6)

Part Number	Case	Packaging		
MMBD4448W-7-F	SOT-323	3000/Tape & Reel		

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# Marking Information



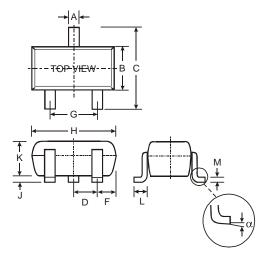
KA3 = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Kev

Year	2002	2003	2004	2005	200	6 20	07	2008	2	2009	2010	2011	2012
Code	N	Р	R	S	Т		U	V		W	Χ	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Ju	I Au	ıg	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	3	9	0	N	D

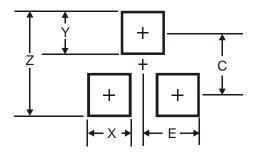


## **Package Outline Dimensions**



SOT-323						
Dim	Min	Max				
Α	0.25	0.40				
В	1.15	1.35				
С	2.00	2.20				
D	0.65 Nominal					
F	0.30	0.40				
G	1.20	1.40				
Н	1.80	2.20				
J	0.0 0.10					
K	0.90	1.00				
L	0.25	0.40				
M	0.10	0.18				
α	0°	8°				
All Dimensions in mm						

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

#### IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

#### LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.